# Silicon P Channel Power MOS FET High Speed Power Switching

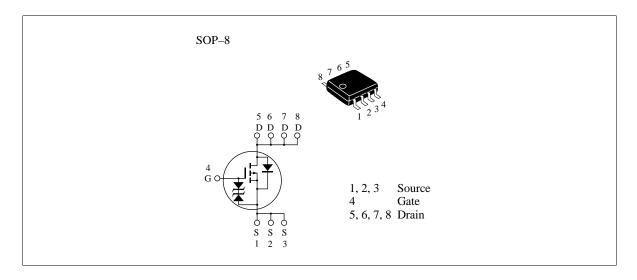
## **HITACHI**

ADE-208-435H (Z) 9th. Edition Feb. 1999

#### **Features**

- Low on-resistance
- Capable of 4 V gate drive
- Low drive current
- High density mounting

#### **Outline**





#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	- 30	V	
Gate to source voltage	$V_{\rm GSS}$	± 20	V	
Drain current	I <sub>D</sub>	-5	A	
Drain peak current	Note1 D(pulse)	<b>- 40</b>	A	
Body-drain diode reverse drain current	I <sub>DR</sub>	-5	A	
Channel dissipation	Pch Note2	2.5	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	−55 to +150	°C	

Note:

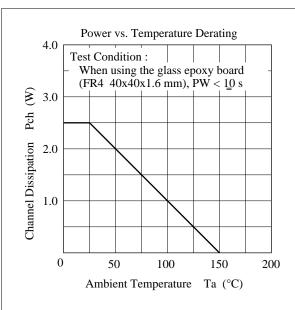
- 1. PW  $\leq$  10 $\mu$ s, duty cycle  $\leq$  1 %
- 2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s

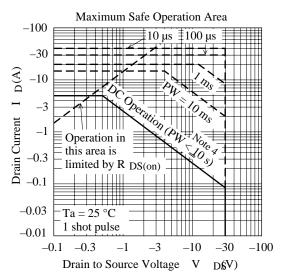
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	- 30	_	_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	_	_	V	$I_{G} = \pm 100 \mu\text{A},  V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>		_	± 10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>		_	-10	μΑ	$V_{DS} = -30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	- 1.0	_	- 2.5	V	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$
Static drain to source on state	R <sub>DS(on)</sub>		0.04	0.07	Ω	$I_D = -3 \text{ A}, V_{GS} = -10 \text{ V}^{\text{Note3}}$
resistance	R <sub>DS(on)</sub>		0.07	0.13	Ω	$I_D = -3 \text{ A}, V_{GS} = -4 \text{ V}^{\text{Note3}}$
Forward transfer admittance	y <sub>fs</sub>	5.0	7.5	_	S	$I_D = -3 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note3}}$
Input capacitance	Ciss	_	860	_	pF	$V_{DS} = -10 \text{ V}$
Output capacitance	Coss	_	560	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss		165	_	pF	f = 1MHz
Turn-on delay time	$t_{d(on)}$	_	30	_	ns	$V_{GS} = -4 \text{ V}, I_{D} = -3 \text{ A}$
Rise time	t <sub>r</sub>		170	_	ns	$V_{DD} \cong -10 \text{ V}$
Turn-off delay time	$t_{\text{d(off)}}$		40	_	ns	
Fall time	t <sub>f</sub>		65	_	ns	
Body-drain diode forward voltage	$V_{DF}$	_	- 0.9	- 1.4	V	$IF = -5 A$ , $V_{GS} = 0$ Note3
Body–drain diode reverse recovery time	t <sub>rr</sub>	_	55	_	ns	$IF = -5 A, V_{GS} = 0$ diF/ dt = 20 A/µs

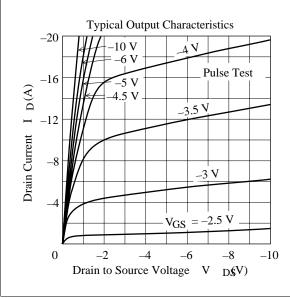
Note: 3. Pulse test

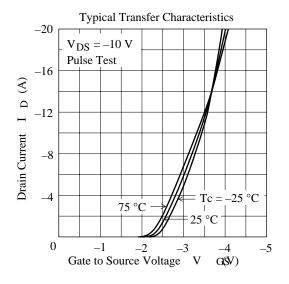
#### **Main Characteristics**

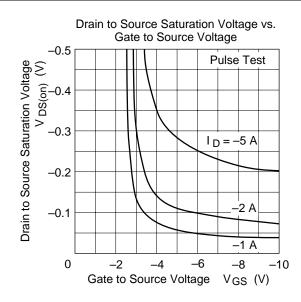


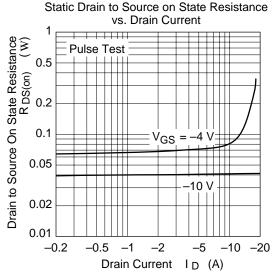


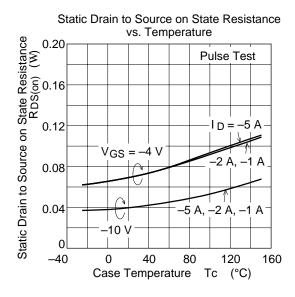
Note 4: When using the glass epoxy board (FR4 40 x 40 x 1.6 mm)

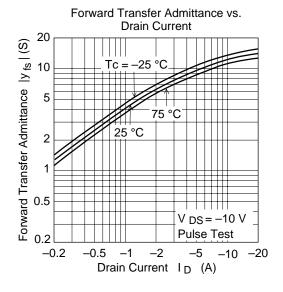


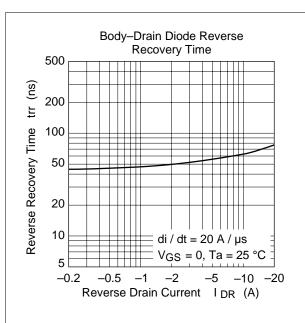


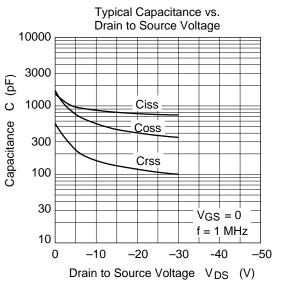


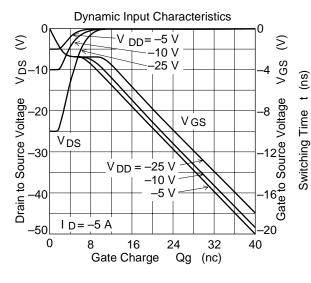


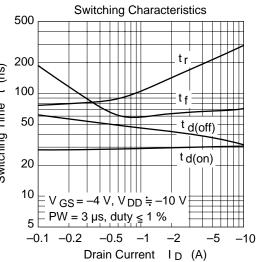


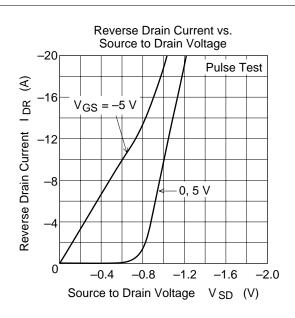


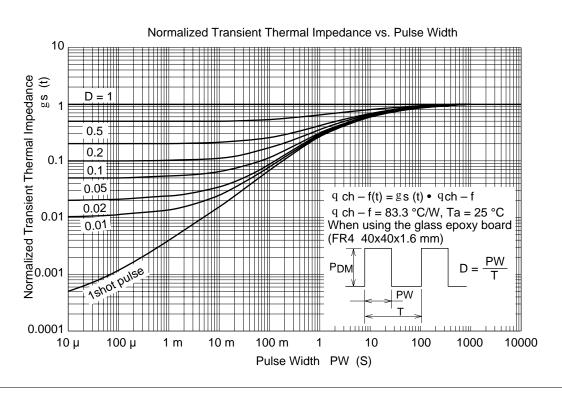


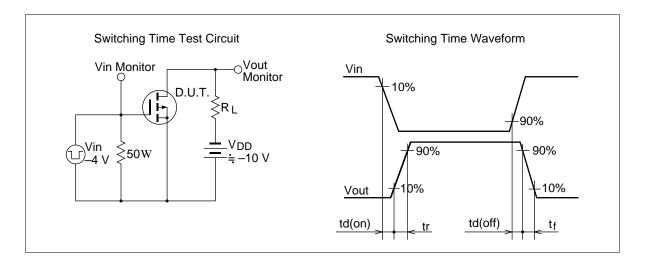




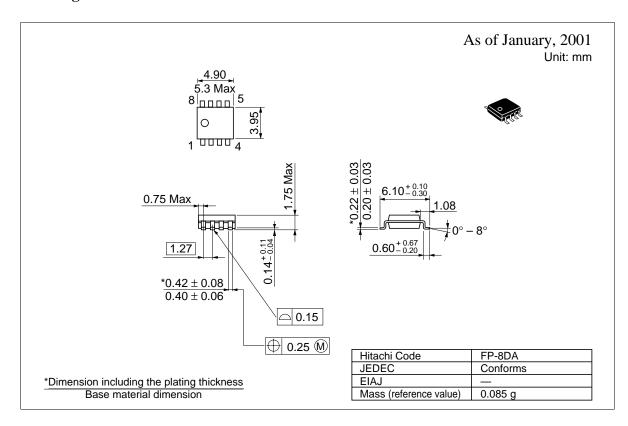








### **Package Dimensions**



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